

International **IR** Rectifier

PD - 95091B

IRLR7821PbF

IRLU7821PbF

HEXFET® Power MOSFET

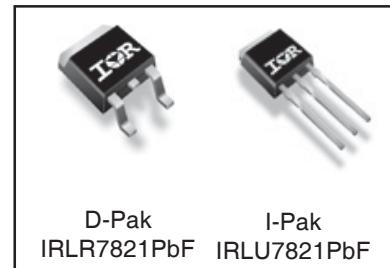
Applications

- High Frequency Synchronous Buck
Converters for Computer Processor Power
- High Frequency Isolated DC-DC
Converters with Synchronous Rectification
for Telecom and Industrial Use
- Lead-Free

Benefits

- Very Low RDS(on) at 4.5V V_{GS}
- Ultra-Low Gate Impedance
- Fully Characterized Avalanche Voltage
and Current

V _{DSS}	R _{DS(on)} max	Q _g
30V	10mΩ	10nC



Absolute Maximum Ratings

	Parameter	Max.	Units
V _{DS}	Drain-to-Source Voltage	30	V
V _{GS}	Gate-to-Source Voltage	± 20	
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	65④	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	47④	A
I _{DM}	Pulsed Drain Current ①	260	
P _D @ T _C = 25°C	Maximum Power Dissipation	75	W
P _D @ T _C = 100°C	Maximum Power Dissipation	37.5	
	Linear Derating Factor	0.50	W/°C
T _J	Operating Junction and	-55 to + 175	°C
T _{STG}	Storage Temperature Range		

Thermal Resistance

	Parameter	Typ.	Max.	Units
R _{0JC}	Junction-to-Case	—	2.0	°C/W
R _{0JA}	Junction-to-Ambient (PCB Mount)⑤	—	50	
R _{0JA}	Junction-to-Ambient	—	110	

Notes ① through ⑤ are on page 11

IRLR/U7821PbF

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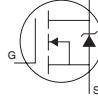
Static @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	30	—	—	V	$V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	23	—	mV/ $^\circ\text{C}$	Reference to 25°C , $I_D = 1\text{mA}$
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	7.5	10	m Ω	$V_{GS} = 10\text{V}$, $I_D = 15\text{A}$ ④
		—	9.5	12.5		$V_{GS} = 4.5\text{V}$, $I_D = 12\text{A}$ ④
$V_{GS(th)}$	Gate Threshold Voltage	1.0	—	—	V	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$
$\Delta V_{GS(th)}$	Gate Threshold Voltage Coefficient	—	-5.3	—	mV/ $^\circ\text{C}$	
I_{DSS}	Drain-to-Source Leakage Current	—	—	1.0	μA	$V_{DS} = 24\text{V}$, $V_{GS} = 0\text{V}$
		—	—	150		$V_{DS} = 24\text{V}$, $V_{GS} = 0\text{V}$, $T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{GS} = 20\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{GS} = -20\text{V}$
g_{fs}	Forward Transconductance	46	—	—	S	$V_{DS} = 15\text{V}$, $I_D = 12\text{A}$
Q_g	Total Gate Charge	—	10	14	nC	$V_{DS} = 16\text{V}$ $V_{GS} = 4.5\text{V}$ $I_D = 12\text{A}$ See Fig. 16
Q_{gs1}	Pre-V _{th} Gate-to-Source Charge	—	2.0	—		
Q_{gs2}	Post-V _{th} Gate-to-Source Charge	—	1.2	—		
Q_{gd}	Gate-to-Drain Charge	—	2.5	—		
Q_{godr}	Gate Charge Overdrive	—	4.3	—		
Q_{sw}	Switch Charge ($Q_{gs2} + Q_{gd}$)	—	3.7	—		
Q_{oss}	Output Charge	—	8.5	—	nC	$V_{DS} = 16\text{V}$, $V_{GS} = 0\text{V}$
$t_{d(on)}$	Turn-On Delay Time	—	11	—	ns	$V_{DD} = 15\text{V}$, $V_{GS} = 4.5\text{V}$ ④ $I_D = 12\text{A}$ Clamped Inductive Load
t_r	Rise Time	—	4.2	—		
$t_{d(off)}$	Turn-Off Delay Time	—	10	—		
t_f	Fall Time	—	3.2	—		
C_{iss}	Input Capacitance	—	1030	—	pF	$V_{GS} = 0\text{V}$ $V_{DS} = 15\text{V}$ $f = 1.0\text{MHz}$
C_{oss}	Output Capacitance	—	360	—		
C_{rss}	Reverse Transfer Capacitance	—	120	—		

Avalanche Characteristics

	Parameter	Typ.	Max.	Units
E_{AS}	Single Pulse Avalanche Energy ②⑥	—	230	mJ
I_{AR}	Avalanche Current ①	—	12	A
E_{AR}	Repetitive Avalanche Energy ①	—	7.5	mJ

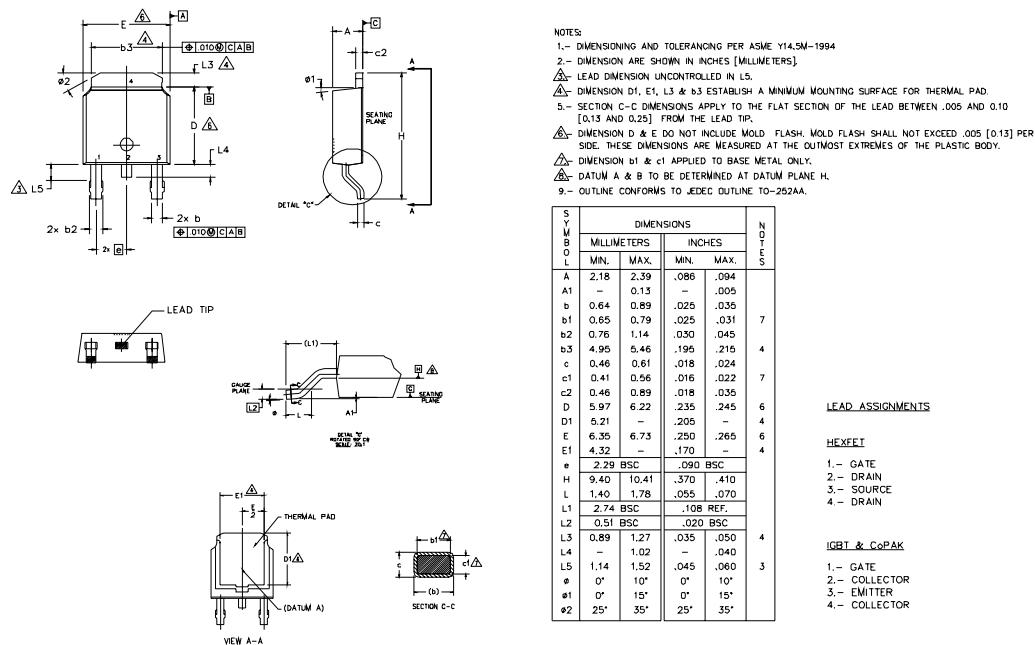
Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_s	Continuous Source Current (Body Diode)	—	—	65 ④	A	MOSFET symbol showing the integral reverse p-n junction diode.
	Pulsed Source Current (Body Diode) ①⑥	—	—	260		
V_{SD}	Diode Forward Voltage	—	—	1.0	V	$T_J = 25^\circ\text{C}$, $I_S = 12\text{A}$, $V_{GS} = 0\text{V}$ ④
t_{rr}	Reverse Recovery Time	—	26	38	ns	$T_J = 25^\circ\text{C}$, $I_F = 12\text{A}$, $V_{DD} = 15\text{V}$
Q_{rr}	Reverse Recovery Charge	—	15	23	nC	$di/dt = 100\text{A}/\mu\text{s}$ ④
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

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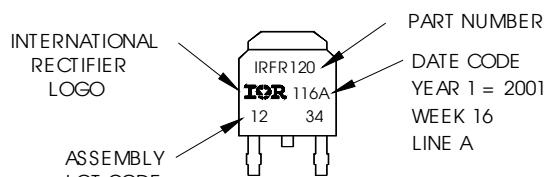
D-Pak (TO-252AA) Package Outline



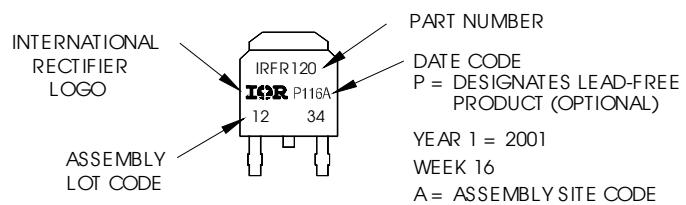
D-Pak (TO-252AA) Part Marking Information

EXAMPLE: THIS IS AN IRFR120
WITH ASSEMBLY
LOT CODE 1234
ASSEMBLED ON WW 16, 2001
IN THE ASSEMBLY LINE "A"

Note: "P" in assembly line position
indicates "Lead-Free"



OR

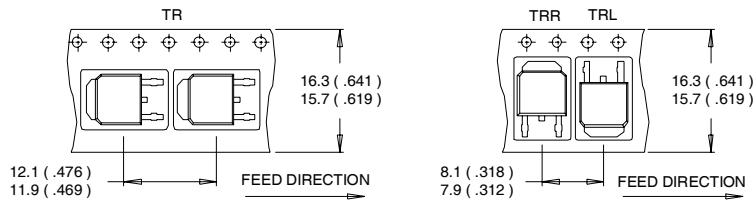


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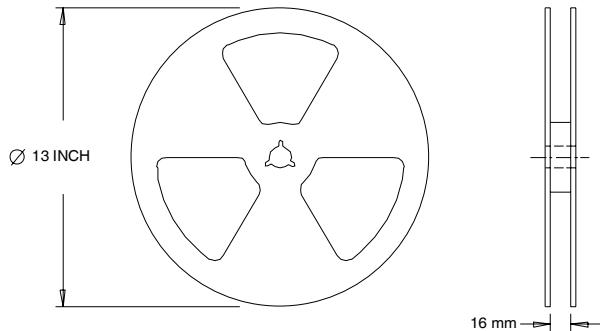
D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. OUTLINE CONFORMS TO EIA-481.

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25^\circ\text{C}$, $L = 3.2\text{mH}$
 $R_G = 25\Omega$, $I_{AS} = 12\text{A}$.
- ③ Pulse width $\leq 400\mu\text{s}$; duty cycle $\leq 2\%$.
- ④ Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 30A.
- ⑤ When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.

Data and specifications subject to change without notice.
This product has been designed and qualified for the Industrial market.
Qualification Standards can be found on IR's Web site.

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